## **Tyrone Camarero Specifications**

## Camarero DSA700TT-224R

## Key features

Compute Intensive Application, HPC, Data Center, Enterprise Server, Hyperscale / Hyperconverged Four hot-pluggable systems (nodes) in a 2U form factor. Each node supports the following:

- Dual AMD EPYC™ 7001/7002\* Series Processors (\*AMD EPYC 7002 series drop-in support requires board revision 2.x)
- System on Chip
- 2TB Registered ECC DDR4 2666MHz SDRAM in 16 DIMMs
- 2 PCI-E 3.0 x16 (LP) slot; 1 SIOM , card support (flexible networking), Note: must bundle with Network card
- IPMI 2.0 + KVM with dedicated LAN
- 6 Hot-swap 2.5" SATA3 drive bays, M.2 Interface: 1 SATA/PCI-E 3.0 x4, M.2 Form Factor: 2280, 22110, M.2 Key: M-key
- Video via Aspeed AST 2500 BMC
- 4 Heavy duty 8cm PWM fans
- 2200W Redundant Power Supplies Titanium Level (96%)







## Processor/Cache

Processor Dual AMD EPYC™ 7001/7002\* Series

Processors (\*AMD EPYC 7002 series

drop-in support requires board revision 2.x)

Chipset

Chipset System on Chip

System Memory

Memory Capacity 2TB Registered ECC DDR4 2666MHz

SDRAM in 16 DIMMs

**Expansion Slots** 

PCI-Express 2 PCI-E 3.0 x16 (LP) slot; 1 SIOM ,card support (flexible networking),Note:

must bundle with Network card

Integrated On-Board

SATA SATA3 (6 Gbps)

LAN Provided via SIOM (optional),1 RJ45

Dedicated IPMI LAN port

Add-on Options

Raid Card Optional

Optical Drive None

Front Panel

LED Power status LED,HDD activity LED,Network

activity LEDs, Universal Information (UID) LED

Buttons Power On/Off button, UID button

**Drive Bays** 

HDD Bays 6 Hot-swap 2.5" SATA3 drive bays, M.2

Interface: 1 SATA/PCI-E 3.0 x4,M.2

Form Factor: 2280, 22110, M.2 Key: M-key

**Power Supply** 

2200W Redundant Power Supplies, Titanium Level (96%)

Cooling System

4 Heavy duty 8cm PWM fans

Form Factor

Form Factor : 2U Rackmount

Height : 3.47" (88mm) Width : 17.25" (438mm)

Depth : 28.5" (724mm)

Email: info@tyronesystems.com

For more/current product information, visit

www.tyronesystems.com

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